



Welcome to [E-XFL.COM](#)

What is "[Embedded - Microcontrollers](#)"?

"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Obsolete
Core Processor	M8C
Core Size	8-Bit
Speed	24MHz
Connectivity	I ² C, SPI, UART/USART
Peripherals	POR, PWM, WDT
Number of I/O	44
Program Memory Size	32KB (32K x 8)
Program Memory Type	FLASH
EEPROM Size	-
RAM Size	2K x 8
Voltage - Supply (Vcc/Vdd)	3V ~ 5.25V
Data Converters	A/D 12x14b; D/A 4x9b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	48-BSSOP (0.295", 7.50mm Width)
Supplier Device Package	48-SSOP
Purchase URL	https://www.e-xfl.com/product-detail/infineon-technologies/cy8c29666-24pvxat

Contents

PSoC Functional Overview	3	DC Electrical Characteristics	16
The Digital System	3	AC Electrical Characteristics	30
The Analog System	4	Packaging Information	40
Additional System Resources	5	Thermal Impedances	41
PSoC Device Characteristics	5	Capacitance on Crystal Pins	41
Getting Started	6	Solder Reflow Specifications	41
Application Notes	6	Tape and Reel Information	42
Development Kits	6	Development Tool Selection	44
Training	6	Software	44
CYPs Consultants	6	Development Kits	44
Solutions Library	6	Evaluation Tools	44
Technical Support	6	Device Programmers	45
Development Tools	7	Accessories (Emulation and Programming)	45
PSoC Designer Software Subsystems	7	Ordering Information	46
Designing with PSoC Designer	8	Ordering Code Definitions	46
Select User Modules	8	Reference Information	47
Configure User Modules	8	Acronyms	47
Organize and Connect	8	Reference Documents	47
Generate, Verify, and Debug	8	Document Conventions	48
Pinouts	9	Glossary	48
28-Pin Part Pinout	9	Document History Page	53
48-Pin Part Pinout	10	Sales, Solutions, and Legal Information	55
Registers	11	Worldwide Sales and Design Support	55
Register Conventions	11	Products	55
Register Mapping Tables	11	PSoC® Solutions	55
Electrical Specifications	14	Cypress Developer Community	55
Absolute Maximum Ratings	15	Technical Support	55
Operating Temperature	15		

Getting Started

For in depth information, along with detailed programming details, see the *PSoC[®] Technical Reference Manual*.

For up-to-date ordering, packaging, and electrical specification information, see the latest [PSoC device datasheets](#) on the web.

Application Notes

[Cypress application notes](#) are an excellent introduction to the wide variety of possible PSoC designs.

Development Kits

[PSoC Development Kits](#) are available online from and through a growing number of regional and global distributors, which include Arrow, Avnet, Digi-Key, Farnell, Future Electronics, and Newark.

Training

[Free PSoC technical training](#) (on demand, webinars, and workshops), which is available online via www.cypress.com, covers a wide variety of topics and skill levels to assist you in your designs.

CYPros Consultants

Certified PSoC consultants offer everything from technical assistance to completed PSoC designs. To contact or become a PSoC consultant go to the [CYPros Consultants](#) web site.

Solutions Library

Visit our growing [library of solution focused designs](#). Here you can find various application designs that include firmware and hardware design files that enable you to complete your designs quickly.

Technical Support

[Technical support](#) – including a searchable Knowledge Base articles and technical forums – is also available online. If you cannot find an answer to your question, call our Technical Support hotline at 1-800-541-4736.

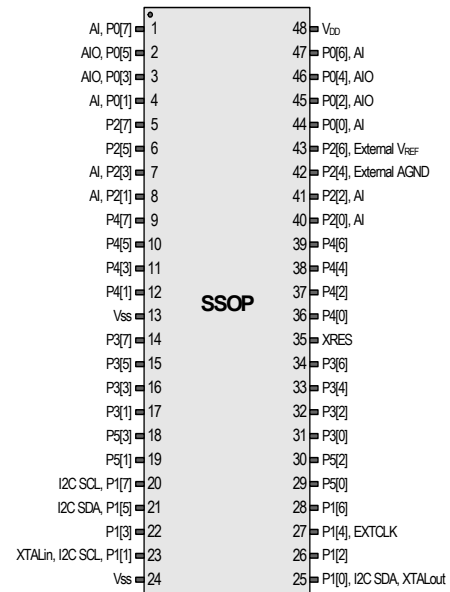
48-Pin Part Pinout

Table 3. 48-Pin Part Pinout (SSOP)

Pin No.	Type		Pin Name	Description
	Digital	Analog		
1	I/O	I	P0[7]	Analog column mux input
2	I/O	I/O	P0[5]	Analog column mux input and column output
3	I/O	I/O	P0[3]	Analog column mux input and column output
4	I/O	I	P0[1]	Analog column mux input
5	I/O		P2[7]	
6	I/O		P2[5]	
7	I/O	I	P2[3]	Direct switched capacitor block input
8	I/O	I	P2[1]	Direct switched capacitor block input
9	I/O		P4[7]	
10	I/O		P4[5]	
11	I/O		P4[3]	
12	I/O		P4[1]	
13	Power		V _{SS}	Ground connection
14	I/O		P3[7]	
15	I/O		P3[5]	
16	I/O		P3[3]	
17	I/O		P3[1]	
18	I/O		P5[3]	
19	I/O		P5[1]	
20	I/O		P1[7]	I ² C serial clock (SCL)
21	I/O		P1[5]	I ² C serial data (SDA)
22	I/O		P1[3]	
23	I/O		P1[1]	Crystal input (XTALin), I ² C serial clock (SCL), ISSP-SCLK ^[6]
24	Power		V _{SS}	Ground connection
25	I/O		P1[0]	Crystal output (XTALout), I ² C Serial Data (SDA), ISSP-SDATA ^[6]
26	I/O		P1[2]	
27	I/O		P1[4]	Optional external clock (EXTCLK) input
28	I/O		P1[6]	
29	I/O		P5[0]	
30	I/O		P5[2]	
31	I/O		P3[0]	
32	I/O		P3[2]	
33	I/O		P3[4]	
34	I/O		P3[6]	
35	Input		XRES	Active high external reset with internal pull-down
36	I/O		P4[0]	
37	I/O		P4[2]	
38	I/O		P4[4]	
39	I/O		P4[6]	
40	I/O	I	P2[0]	Direct switched capacitor block input
41	I/O	I	P2[2]	Direct switched capacitor block input
42	I/O		P2[4]	External analog ground (AGND)
43	I/O		P2[6]	External voltage reference (V _{REF})
44	I/O	I	P0[0]	Analog column mux input
45	I/O	I/O	P0[2]	Analog column mux input and column output
46	I/O	I/O	P0[4]	Analog column mux input and column output
47	I/O	I	P0[6]	Analog column mux input
48	Power		V _{DD}	Supply voltage

LEGEND: A = Analog, I = Input, and O = Output.

Figure 4. CY8C29666 48-Pin PSoC Device



Note

6. These are the ISSP pins, which are not high Z when coming out of POR. See the *PSoC Technical Reference Manual* for details.

Registers

Register Conventions

This section lists the registers of the automotive CY8C29x66 PSoC device. For detailed register information, refer to the [PSoC Technical Reference Manual](#).

The register conventions specific to this section are listed in the following table.

Table 4. Abbreviations

Convention	Description
R	Read register or bit(s)
W	Write register or bit(s)
L	Logical register or bit(s)
C	Clearable register or bit(s)
#	Access is bit specific

Register Mapping Tables

The PSoC device has a total register address space of 512 bytes. The register space is referred to as I/O space and is divided into two banks, bank 0 and bank 1. The XIO bit in the Flag register (CPU_F) determines which bank the user is currently in. When the XIO bit is set to '1', the user is in bank 1.

Note In the following register mapping tables, blank fields are Reserved and must not be accessed.

Table 5. Register Map Bank 0 Table: User Space

Name	Addr (0, Hex)	Access	Name	Addr (0, Hex)	Access	Name	Addr (0, Hex)	Access	Name	Addr (0, Hex)	Access
PRT0DR	00	RW	DBB20DR0	40	#	ASC10CR0	80	RW	RD12RI	C0	RW
PRT0IE	01	RW	DBB20DR1	41	W	ASC10CR1	81	RW	RD12SYN	C1	RW
PRT0GS	02	RW	DBB20DR2	42	RW	ASC10CR2	82	RW	RD12IS	C2	RW
PRT0DM2	03	RW	DBB20CR0	43	#	ASC10CR3	83	RW	RD12LT0	C3	RW
PRT1DR	04	RW	DBB21DR0	44	#	ASD11CR0	84	RW	RD12LT1	C4	RW
PRT1IE	05	RW	DBB21DR1	45	W	ASD11CR1	85	RW	RD12RO0	C5	RW
PRT1GS	06	RW	DBB21DR2	46	RW	ASD11CR2	86	RW	RD12RO1	C6	RW
PRT1DM2	07	RW	DBB21CR0	47	#	ASD11CR3	87	RW		C7	
PRT2DR	08	RW	DCB22DR0	48	#	ASC12CR0	88	RW	RD13RI	C8	RW
PRT2IE	09	RW	DCB22DR1	49	W	ASC12CR1	89	RW	RD13SYN	C9	RW
PRT2GS	0A	RW	DCB22DR2	4A	RW	ASC12CR2	8A	RW	RD13IS	CA	RW
PRT2DM2	0B	RW	DCB22CR0	4B	#	ASC12CR3	8B	RW	RD13LT0	CB	RW
PRT3DR	0C	RW	DCB23DR0	4C	#	ASD13CR0	8C	RW	RD13LT1	CC	RW
PRT3IE	0D	RW	DCB23DR1	4D	W	ASD13CR1	8D	RW	RD13RO0	CD	RW
PRT3GS	0E	RW	DCB23DR2	4E	RW	ASD13CR2	8E	RW	RD13RO1	CE	RW
PRT3DM2	0F	RW	DCB23CR0	4F	#	ASD13CR3	8F	RW		CF	
PRT4DR	10	RW	DBB30DR0	50	#	ASD20CR0	90	RW	CUR_PP	D0	RW
PRT4IE	11	RW	DBB30DR1	51	W	ASD20CR1	91	RW	STK_PP	D1	RW
PRT4GS	12	RW	DBB30DR2	52	RW	ASD20CR2	92	RW		D2	
PRT4DM2	13	RW	DBB30CR0	53	#	ASD20CR3	93	RW	IDX_PP	D3	RW
PRT5DR	14	RW	DBB31DR0	54	#	ASC21CR0	94	RW	MVR_PP	D4	RW
PRT5IE	15	RW	DBB31DR1	55	W	ASC21CR1	95	RW	MWV_PP	D5	RW
PRT5GS	16	RW	DBB31DR2	56	RW	ASC21CR2	96	RW	I2C_CFG	D6	RW
PRT5DM2	17	RW	DBB31CR0	57	#	ASC21CR3	97	RW	I2C_SCR	D7	#
	18		DCB32DR0	58	#	ASD22CR0	98	RW	I2C_DR	D8	RW
	19		DCB32DR1	59	W	ASD22CR1	99	RW	I2C_MSCR	D9	#
	1A		DCB32DR2	5A	RW	ASD22CR2	9A	RW	INT_CLR0	DA	RW
	1B		DCB32CR0	5B	#	ASD22CR3	9B	RW	INT_CLR1	DB	RW
	1C		DCB33DR0	5C	#	ASC23CR0	9C	RW	INT_CLR2	DC	RW
	1D		DCB33DR1	5D	W	ASC23CR1	9D	RW	INT_CLR3	DD	RW
	1E		DCB33DR2	5E	RW	ASC23CR2	9E	RW	INT_MSK3	DE	RW
	1F		DCB33CR0	5F	#	ASC23CR3	9F	RW	INT_MSK2	DF	RW
DBB00DR0	20	#	AMX_IN	60	RW		A0		INT_MSK0	E0	RW
DBB00DR1	21	W		61			A1		INT_MSK1	E1	RW
DBB00DR2	22	RW		62			A2		INT_VC	E2	RC
DBB00CR0	23	#	ARF_CR	63	RW		A3		RES_WDT	E3	W
DBB01DR0	24	#	CMP_CR0	64	#		A4		DEC_DH	E4	RC
DBB01DR1	25	W	ASY_CR	65	#		A5		DEC_DL	E5	RC
DBB01DR2	26	RW	CMP_CR1	66	RW		A6		DEC_CR0	E6	RW
DBB01CR0	27	#		67			A7		DEC_CR1	E7	RW
DCB02DR0	28	#		68		MUL1_X	A8	W	MUL0_X	E8	W
DCB02DR1	29	W		69		MUL1_Y	A9	W	MUL0_Y	E9	W
DCB02DR2	2A	RW		6A		MUL1_DH	AA	R	MUL0_DH	EA	R
DCB02CR0	2B	#		6B		MUL1_DL	AB	R	MUL0_DL	EB	R
DCB03DR0	2C	#	TMP_DR0	6C	RW	ACC1_DR1	AC	RW	ACC0_DR1	EC	RW
DCB03DR1	2D	W	TMP_DR1	6D	RW	ACC1_DR0	AD	RW	ACC0_DR0	ED	RW
DCB03DR2	2E	RW	TMP_DR2	6E	RW	ACC1_DR3	AE	RW	ACC0_DR3	EE	RW
DCB03CR0	2F	#	TMP_DR3	6F	RW	ACC1_DR2	AF	RW	ACC0_DR2	EF	RW
DBB10DR0	30	#	ACB00CR3	70	RW	RDI0RI	B0	RW		F0	
DBB10DR1	31	W	ACB00CR0	71	RW	RD10SYN	B1	RW		F1	
DBB10DR2	32	RW	ACB00CR1	72	RW	RD10IS	B2	RW		F2	
DBB10CR0	33	#	ACB00CR2	73	RW	RD10LT0	B3	RW		F3	
DBB11DR0	34	#	ACB01CR3	74	RW	RD10LT1	B4	RW		F4	
DBB11DR1	35	W	ACB01CR0	75	RW	RD10RO0	B5	RW		F5	
DBB11DR2	36	RW	ACB01CR1	76	RW	RD10RO1	B6	RW		F6	
DBB11CR0	37	#	ACB01CR2	77	RW		B7		CPU_F	F7	RL
DCB12DR0	38	#	ACB02CR3	78	RW	RD11RI	B8	RW		F8	
DCB12DR1	39	W	ACB02CR0	79	RW	RD11SYN	B9	RW		F9	
DCB12DR2	3A	RW	ACB02CR1	7A	RW	RD11IS	BA	RW		FA	
DCB12CR0	3B	#	ACB02CR2	7B	RW	RD11LT0	BB	RW		FB	
DCB13DR0	3C	#	ACB03CR3	7C	RW	RD11LT1	BC	RW		FC	
DCB13DR1	3D	W	ACB03CR0	7D	RW	RD11RO0	BD	RW		FD	
DCB13DR2	3E	RW	ACB03CR1	7E	RW	RD11RO1	BE	RW	CPU_SCR1	FE	#
DCB13CR0	3F	#	ACB03CR2	7F	RW		BF		CPU_SCR0	FF	#

Blank fields are Reserved and should not be accessed.

Access is bit specific.

DC Electrical Characteristics

DC Chip-Level Specifications

Table 9 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, or 3.0 V to 3.6 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, respectively. Typical parameters apply to 5 V and 3.3 V at 25°C and are for design guidance only.

Table 9. DC Chip-Level Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
V_{DD}	Supply voltage	3.00	–	5.25	V	See DC POR and LVD Specifications on page 28.
I_{DD}	Supply current	–	8	14	mA	Conditions are 5.25 V, CPU = 3 MHz, 48 MHz disabled, VC1 = 1.5 MHz, VC2 = 93.75 kHz, VC3 = 0.366 kHz.
I_{DD3}	Supply current	–	5	9	mA	Conditions are $V_{DD} = 3.3$ V, CPU = 3 MHz, 48 MHz disabled, VC1 = 1.5 MHz, VC2 = 93.75 kHz, VC3 = 0.366 kHz.
I_{DDP}	Supply current when IMO = 6 MHz using SLIMO mode.	–	2	3	mA	Conditions are $V_{DD} = 3.3$ V, CPU = 3 MHz, 48 MHz disabled, VC1 = 0.375 MHz, VC2 = 23.44 kHz, VC3 = 0.09 kHz.
I_{SB}	Sleep (mode) current with POR, LVD, sleep timer, WDT, and ILO active.	–	4	25	μA	Conditions are with internal low speed oscillator, $V_{DD} = 3.3$ V, $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$.
I_{SBXTL}	Sleep (mode) current with POR, LVD, sleep timer, WDT, ILO, and 32-kHz crystal oscillator active.	–	4	27	μA	Conditions are with properly loaded, 1 μW max, 32.768 kHz crystal. $V_{DD} = 3.3$ V, $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$.
V_{REF}	Reference voltage (bandgap)	1.28	1.3	1.32	V	Trimmed for appropriate V_{DD} .

DC General Purpose I/O Specifications

Table 10 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, or 3.0 V to 3.6 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, respectively. Typical parameters apply to 5 V and 3.3 V at 25°C and are for design guidance only.

Table 10. DC GPIO Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
R_{PU}	Pull-up resistor	4	5.6	8	$k\Omega$	
R_{PD}	Pull-down resistor	4	5.6	8	$k\Omega$	Also applies to the internal pull-down resistor on the XRES pin.
V_{OH}	High output level	$V_{DD} - 1.0$	–	–	V	$I_{OH} = 10$ mA, $V_{DD} = 4.75$ to 5.25 V (8 total loads, 4 on even port pins (for example, P0[2], P1[4]), 4 on odd port pins (for example, P0[3], P1[5])). 80 mA maximum combined I_{OH} budget.
V_{OL}	Low output level	–	–	0.75	V	$I_{OL} = 25$ mA, $V_{DD} = 4.75$ to 5.25 V (8 total loads, 4 on even port pins (for example, P0[2], P1[4]), 4 on odd port pins (for example, P0[3], P1[5])). 150 mA maximum combined I_{OL} budget.
I_{OH}	High-level source current	10	–	–	mA	$V_{OH} \geq V_{DD} - 1.0$ V, see the limitations of the total current in the note for V_{OH} .
I_{OL}	Low-level sink current	25	–	–	mA	$V_{OL} \leq 0.75$ V, see the limitations of the total current in the note for V_{OL} .
V_{IL}	Input low level	–	–	0.8	V	$V_{DD} = 3.0$ to 5.25 .
V_{IH}	Input high level	2.1	–	–	V	$V_{DD} = 3.0$ to 5.25 .

DC Analog Output Buffer Specifications

Table 14 and Table 15 on page 20 list guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, or 3.0 V to 3.6 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, respectively. Typical parameters apply to 5 V and 3.3 V at 25°C and are for design guidance only.

Table 14. 5-V DC Analog Output Buffer Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
V_{OSOB}	Input offset voltage (absolute value)	–	3.2	18	mV	
TCV_{OSOB}	Average input offset voltage drift	–	5.5	26.0	$\mu\text{V}/^{\circ}\text{C}$	
V_{CMOB}	Common-mode input voltage range	0.5	–	$V_{DD} - 1.0$	V	
R_{OUTOB}	Output resistance Power = low Power = high	– –	– –	1 1	Ω Ω	
$V_{OHIGHOB}$	High output voltage swing (load = $32\ \Omega$ to $V_{DD}/2$) Power = low Power = high	$0.5 \times V_{DD} + 1.3$ $0.5 \times V_{DD} + 1.3$	– –	– –	V V	
V_{LOWOB}	Low output voltage swing (load = $32\ \Omega$ to $V_{DD}/2$) Power = low Power = high	– –	– –	$0.5 \times V_{DD} - 1.3$ $0.5 \times V_{DD} - 1.3$	V V	
I_{SOB}	Supply current including bias cell (no load) Power = low Power = high	– –	1.1 2.6	2 5	mA mA	
$PSRR_{OB}$	Power supply rejection ratio	40	64	–	dB	
C_L	Load capacitance	–	–	200	pF	This specification applies to the external circuit driven by the analog output buffer.

Table 16. 5-V DC Analog Reference Specifications(continued)

Reference ARF_CR[5:3]	Reference Power Settings	Symbol	Reference	Description	Min	Typ	Max	Unit
0b001	RefPower = High Opamp bias = High	V _{REFHI}	Ref High	P2[4] + P2[6] (P2[4] = V _{DD} /2, P2[6] = 1.3 V)	P2[4] + P2[6] – 0.085	P2[4] + P2[6] – 0.016	P2[4] + P2[6] + 0.044	V
		V _{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	–
		V _{REFLO}	Ref Low	P2[4] – P2[6] (P2[4] = V _{DD} /2, P2[6] = 1.3 V)	P2[4] – P2[6] – 0.022	P2[4] – P2[6] + 0.010	P2[4] – P2[6] + 0.055	V
	RefPower = High Opamp bias = Low	V _{REFHI}	Ref High	P2[4] + P2[6] (P2[4] = V _{DD} /2, P2[6] = 1.3 V)	P2[4] + P2[6] – 0.077	P2[4] + P2[6] – 0.010	P2[4] + P2[6] + 0.051	V
		V _{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	–
		V _{REFLO}	Ref Low	P2[4] – P2[6] (P2[4] = V _{DD} /2, P2[6] = 1.3 V)	P2[4] – P2[6] – 0.022	P2[4] – P2[6] + 0.005	P2[4] – P2[6] + 0.039	V
	RefPower = Med Opamp bias = High	V _{REFHI}	Ref High	P2[4] + P2[6] (P2[4] = V _{DD} /2, P2[6] = 1.3 V)	P2[4] + P2[6] – 0.070	P2[4] + P2[6] – 0.010	P2[4] + P2[6] + 0.050	V
		V _{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	–
		V _{REFLO}	Ref Low	P2[4] – P2[6] (P2[4] = V _{DD} /2, P2[6] = 1.3 V)	P2[4] – P2[6] – 0.022	P2[4] – P2[6] + 0.005	P2[4] – P2[6] + 0.039	V
	RefPower = Med Opamp bias = Low	V _{REFHI}	Ref High	P2[4] + P2[6] (P2[4] = V _{DD} /2, P2[6] = 1.3 V)	P2[4] + P2[6] – 0.070	P2[4] + P2[6] – 0.007	P2[4] + P2[6] + 0.054	V
		V _{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	–
		V _{REFLO}	Ref Low	P2[4] – P2[6] (P2[4] = V _{DD} /2, P2[6] = 1.3 V)	P2[4] – P2[6] – 0.022	P2[4] – P2[6] + 0.002	P2[4] – P2[6] + 0.032	V
0b010	RefPower = High Opamp bias = High	V _{REFHI}	Ref High	V _{DD}	V _{DD} – 0.037	V _{DD} – 0.009	V _{DD}	V
		V _{AGND}	AGND	V _{DD} /2	V _{DD} /2 – 0.061	V _{DD} /2 – 0.006	V _{DD} /2 + 0.047	V
		V _{REFLO}	Ref Low	V _{SS}	V _{SS}	V _{SS} + 0.007	V _{SS} + 0.028	V
	RefPower = High Opamp bias = Low	V _{REFHI}	Ref High	V _{DD}	V _{DD} – 0.039	V _{DD} – 0.006	V _{DD}	V
		V _{AGND}	AGND	V _{DD} /2	V _{DD} /2 – 0.049	V _{DD} /2 – 0.005	V _{DD} /2 + 0.036	V
		V _{REFLO}	Ref Low	V _{SS}	V _{SS}	V _{SS} + 0.005	V _{SS} + 0.019	V
	RefPower = Med Opamp bias = High	V _{REFHI}	Ref High	V _{DD}	V _{DD} – 0.037	V _{DD} – 0.007	V _{DD}	V
		V _{AGND}	AGND	V _{DD} /2	V _{DD} /2 – 0.054	V _{DD} /2 – 0.005	V _{DD} /2 + 0.041	V
		V _{REFLO}	Ref Low	V _{SS}	V _{SS}	V _{SS} + 0.006	V _{SS} + 0.024	V
	RefPower = Med Opamp bias = Low	V _{REFHI}	Ref High	V _{DD}	V _{DD} – 0.042	V _{DD} – 0.005	V _{DD}	V
		V _{AGND}	AGND	V _{DD} /2	V _{DD} /2 – 0.046	V _{DD} /2 – 0.004	V _{DD} /2 + 0.034	V
		V _{REFLO}	Ref Low	V _{SS}	V _{SS}	V _{SS} + 0.004	V _{SS} + 0.017	V

Table 17. 3.3-V DC Analog Reference Specifications (continued)

Reference ARF_CR[5:3]	Reference Power Settings	Symbol	Reference	Description	Min	Typ	Max	Unit
0b010	RefPower = High Opamp bias = High	V _{REFHI}	Ref High	V _{DD}	V _{DD} – 0.06	V _{DD} – 0.010	V _{DD}	V
		V _{AGND}	AGND	V _{DD} /2	V _{DD} /2 – 0.05	V _{DD} /2 – 0.002	V _{DD} /2 + 0.040	V
		V _{REFLO}	Ref Low	V _{SS}	V _{SS}	V _{SS} + 0.009	V _{SS} + 0.056	V
	RefPower = High Opamp bias = Low	V _{REFHI}	Ref High	V _{DD}	V _{DD} – 0.060	V _{DD} – 0.006	V _{DD}	V
		V _{AGND}	AGND	V _{DD} /2	V _{DD} /2 – 0.028	V _{DD} /2 – 0.001	V _{DD} /2 + 0.025	V
		V _{REFLO}	Ref Low	V _{SS}	V _{SS}	V _{SS} + 0.005	V _{SS} + 0.034	V
	RefPower = Med Opamp bias = High	V _{REFHI}	Ref High	V _{DD}	V _{DD} – 0.058	V _{DD} – 0.008	V _{DD}	V
		V _{AGND}	AGND	V _{DD} /2	V _{DD} /2 – 0.037	V _{DD} /2 – 0.002	V _{DD} /2 + 0.033	V
		V _{REFLO}	Ref Low	V _{SS}	V _{SS}	V _{SS} + 0.007	V _{SS} + 0.046	V
	RefPower = Med Opamp bias = Low	V _{REFHI}	Ref High	V _{DD}	V _{DD} – 0.057	V _{DD} – 0.006	V _{DD}	V
		V _{AGND}	AGND	V _{DD} /2	V _{DD} /2 – 0.025	V _{DD} /2 – 0.001	V _{DD} /2 + 0.022	V
		V _{REFLO}	Ref Low	V _{SS}	V _{SS}	V _{SS} + 0.004	V _{SS} + 0.030	V
0b011	All power settings. Not allowed for 3.3 V	–	–	–	–	–	–	–
0b100	All power settings. Not allowed for 3.3 V	–	–	–	–	–	–	–
0b101	RefPower = High Opamp bias = High	V _{REFHI}	Ref High	P2[4] + BandGap (P2[4] = V _{DD} /2)	P2[4] + 1.213	P2[4] + 1.291	P2[4] + 1.367	V
		V _{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	V
		V _{REFLO}	Ref Low	P2[4] – BandGap (P2[4] = V _{DD} /2)	P2[4] – 1.333	P2[4] – 1.294	P2[4] – 1.208	V
	RefPower = High Opamp bias = Low	V _{REFHI}	Ref High	P2[4] + BandGap (P2[4] = V _{DD} /2)	P2[4] + 1.217	P2[4] + 1.294	P2[4] + 1.368	V
		V _{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	V
		V _{REFLO}	Ref Low	P2[4] – BandGap (P2[4] = V _{DD} /2)	P2[4] – 1.320	P2[4] – 1.296	P2[4] – 1.261	V
	RefPower = Med Opamp bias = High	V _{REFHI}	Ref High	P2[4] + BandGap (P2[4] = V _{DD} /2)	P2[4] + 1.217	P2[4] + 1.294	P2[4] + 1.369	V
		V _{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	V
		V _{REFLO}	Ref Low	P2[4] – BandGap (P2[4] = V _{DD} /2)	P2[4] – 1.322	P2[4] – 1.297	P2[4] – 1.262	V
	RefPower = Med Opamp bias = Low	V _{REFHI}	Ref High	P2[4] + BandGap (P2[4] = V _{DD} /2)	P2[4] + 1.219	P2[4] + 1.295	P2[4] + 1.37	V
		V _{AGND}	AGND	P2[4]	P2[4]	P2[4]	P2[4]	V
		V _{REFLO}	Ref Low	P2[4] – BandGap (P2[4] = V _{DD} /2)	P2[4] – 1.324	P2[4] – 1.297	P2[4] – 1.262	V

Table 17. 3.3-V DC Analog Reference Specifications (continued)

Reference ARF_CR[5:3]	Reference Power Settings	Symbol	Reference	Description	Min	Typ	Max	Unit
0b110	RefPower = High Opamp bias = High	V _{REFHI}	Ref High	2 × BandGap	2.507	2.598	2.698	V
		V _{AGND}	AGND	BandGap	1.203	1.307	1.424	V
		V _{REFLO}	Ref Low	V _{ss}	V _{ss}	V _{ss} + 0.012	V _{ss} + 0.067	V
	RefPower = High Opamp bias = Low	V _{REFHI}	Ref High	2 × BandGap	2.516	2.598	2.683	V
		V _{AGND}	AGND	BandGap	1.241	1.303	1.376	V
		V _{REFLO}	Ref Low	V _{ss}	V _{ss}	V _{ss} + 0.007	V _{ss} + 0.040	V
	RefPower = Med Opamp bias = High	V _{REFHI}	Ref High	2 × BandGap	2.510	2.599	2.693	V
		V _{AGND}	AGND	BandGap	1.240	1.305	1.374	V
		V _{REFLO}	Ref Low	V _{ss}	V _{ss}	V _{ss} + 0.008	V _{ss} + 0.048	V
	RefPower = Med Opamp bias = Low	V _{REFHI}	Ref High	2 × BandGap	2.515	2.598	2.683	V
		V _{AGND}	AGND	BandGap	1.258	1.302	1.355	V
		V _{REFLO}	Ref Low	V _{ss}	V _{ss}	V _{ss} + 0.005	V _{ss} + 0.03	V
0b111	All power settings. Not allowed for 3.3 V.	—	—	—	—	—	—	—

DC Analog PSoC Block Specifications

Table 18 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 85\text{ }^{\circ}\text{C}$, or 3.0 V to 3.6 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 85\text{ }^{\circ}\text{C}$, respectively. Typical parameters apply to 5 V and 3.3 V at 25 °C and are for design guidance only.

Table 18. DC Analog PSoC Block Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
R _{CT}	Resistor unit value (continuous time)	—	12.2	—	kΩ	
C _{SC}	Capacitor unit value (switch cap)	—	80	—	fF	

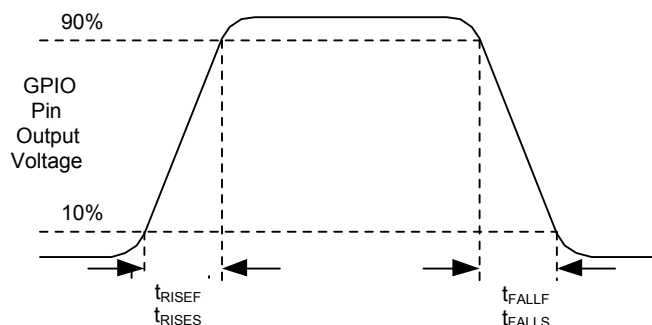
AC GPIO Specifications

Table 22 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, or 3.0 V to 3.6 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, respectively. Typical parameters apply to 5 V and 3.3 V at 25°C and are for design guidance only.

Table 22. AC GPIO Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
F_{GPIO}	GPIO operating frequency	0	—	12.6 ^[15]	MHz	Normal strong mode
t_{RISEF}	Rise time, normal strong mode, Cload = 50 pF	3	—	18	ns	$V_{\text{DD}} = 4.75$ to 5.25 V, 10% - 90%
t_{FALLF}	Fall time, normal strong mode, Cload = 50 pF	2	—	18	ns	$V_{\text{DD}} = 4.75$ to 5.25 V, 10% - 90%
t_{RISES}	Rise time, slow strong mode, Cload = 50 pF	10	27	—	ns	$V_{\text{DD}} = 3$ to 5.25 V, 10% - 90%
t_{FALLS}	Fall time, slow strong mode, Cload = 50 pF	10	22	—	ns	$V_{\text{DD}} = 3$ to 5.25 V, 10% - 90%

Figure 10. GPIO Timing Diagram



Note

15. Accuracy derived from IMO with appropriate trim for V_{DD} range.

Table 26. AC Digital Block Specifications (continued)

Function	Description	Min	Typ	Max	Units	Notes
Receiver	Input clock frequency					The baud rate is equal to the input clock frequency divided by 8.
	$V_{DD} \geq 4.75$ V, 2 stop bits	–	–	50.4 ^[18]	MHz	
	$V_{DD} \geq 4.75$ V, 1 stop bit	–	–	25.2 ^[18]	MHz	
	$V_{DD} < 4.75$ V	–	–	25.2 ^[18]	MHz	

AC Analog Output Buffer Specifications

Table 27 and Table 28 list guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, or 3.0 V to 3.6 V and $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$, respectively. Typical parameters apply to 5 V and 3.3 V at 25°C and are for design guidance only.

Table 27. 5-V AC Analog Output Buffer Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
t_{ROB}	Rising settling time to 0.1%, 1-V step, 100 pF load Power = low Power = high	–	–	4	μs	
		–	–	4	μs	
t_{SOB}	Falling settling time to 0.1%, 1-V step, 100 pF load Power = low Power = high	–	–	3.4	μs	
		–	–	3.4	μs	
SR_{ROB}	Rising slew rate (20% to 80%), 1-V step, 100 pF load Power = low Power = high	0.5	–	–	V/ μs	
		0.5	–	–	V/ μs	
SR_{FOB}	Falling slew rate (80% to 20%), 1-V step, 100 pF load Power = low Power = high	0.55	–	–	V/ μs	
		0.55	–	–	V/ μs	
BW_{OB}	Small signal bandwidth, 20 mV _{pp} , 3 dB BW, 100 pF load Power = low Power = high	0.8	–	–	MHz	
		0.8	–	–	MHz	
BW_{OB}	Large signal bandwidth, 1 V _{pp} , 3 dB BW, 100 pF load Power = low Power = high	300	–	–	kHz	
		300	–	–	kHz	

Table 28. 3.3-V AC Analog Output Buffer Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
t_{ROB}	Rising settling time to 0.1%, 1-V step, 100 pF load Power = low Power = high	–	–	4.7	μs	
		–	–	4.7	μs	
t_{SOB}	Falling settling time to 0.1%, 1-V step, 100 pF load Power = low Power = high	–	–	4	μs	
		–	–	4	μs	
SR_{ROB}	Rising slew rate (20% to 80%), 1-V step, 100 pF load Power = low Power = high	0.36	–	–	V/ μs	
		0.36	–	–	V/ μs	
SR_{FOB}	Falling slew rate (80% to 20%), 1-V step, 100 pF load Power = low Power = high	0.4	–	–	V/ μs	
		0.4	–	–	V/ μs	
BW_{OB}	Small signal bandwidth, 20 mV _{pp} , 3 dB BW, 100 pF load Power = low Power = high	0.7	–	–	MHz	
		0.7	–	–	MHz	
BW_{OB}	Large signal bandwidth, 1 V _{pp} , 3 dB BW, 100 pF load Power = low Power = high	200	–	–	kHz	
		200	–	–	kHz	

Note

18. Accuracy derived from IMO with appropriate trim for V_{DD} range.

AC External Clock Specifications

Table 29 and Table 30 list guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 85\text{ }^{\circ}\text{C}$, or 3.0 V to 3.6 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 85\text{ }^{\circ}\text{C}$, respectively. Typical parameters apply to 5 V and 3.3 V at 25 °C and are for design guidance only.

Table 29. 5-V AC External Clock Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
F _{OSCEXT}	Frequency	0.093	–	24.6	MHz	
–	High period	20.6	–	5300	ns	
–	Low period	20.6	–	–	ns	
–	Power-up IMO to switch	150	–	–	μs	

Table 30. 3.3-V AC External Clock Specifications

Symbol	Description	Min	Typ	Max	Units	Notes
F _{OSCEXT}	Frequency with CPU clock divide by 1	0.093	–	12.3	MHz	Maximum CPU frequency is 12 MHz at 3.3 V. With the CPU clock divider set to 1, the external clock must adhere to the maximum frequency and duty cycle requirements.
F _{OSCEXT}	Frequency with CPU clock divide by 2 or greater	0.093	–	24.6	MHz	If the frequency of the external clock is greater than 12 MHz, the CPU clock divider must be set to 2 or greater. In this case, the CPU clock divider will ensure that the fifty percent duty cycle requirement is met.
–	High period with CPU Clock divide by 1	41.7	–	5300	ns	
–	Low period with CPU Clock divide by 1	41.7	–	–	ns	
–	Power-up IMO to switch	150	–	–	μs	

AC Programming Specifications

Table 31 lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 85\text{ }^{\circ}\text{C}$, or 3.0 V to 3.6 V and $-40\text{ }^{\circ}\text{C} \leq T_A \leq 85\text{ }^{\circ}\text{C}$, respectively. Typical parameters apply to 5 V and 3.3 V at 25 °C and are for design guidance only.

Table 31. AC Programming Specifications

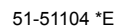
Symbol	Description	Min	Typ	Max	Units	Notes
t_{RSCLK}	Rise time of SCLK	1	–	20	ns	
t_{FSCLK}	Fall time of SCLK	1	–	20	ns	
t_{SSCLK}	Data setup time to falling edge of SCLK	40	–	–	ns	
t_{HSCLK}	Data hold time from falling edge of SCLK	40	–	–	ns	
F_{SCLK}	Frequency of SCLK	0	–	8	MHz	
t_{ERASEB}	Flash erase time (block)	–	10	40 ^[19]	ms	
t_{WRITE}	Flash block write time	–	40	160 ^[19]	ms	
t_{DSCLK}	Data out delay from falling edge of SCLK	–	–	45	ns	$V_{\text{DD}} > 3.6$
t_{DSCLK3}	Data out delay from falling edge of SCLK	–	–	50	ns	$3.0 \leq V_{\text{DD}} \leq 3.6$
t_{PRGH}	Total flash block program time ($t_{\text{ERASEB}} + t_{\text{WRITE}}$), hot	–	–	100 ^[19]	ms	$T_J \geq 0\text{ }^{\circ}\text{C}$
t_{PRGC}	Total flash block program time ($t_{\text{ERASEB}} + t_{\text{WRITE}}$), cold	–	–	200 ^[19]	ms	$T_J < 0\text{ }^{\circ}\text{C}$

Note

19. For the full temperature range, the user must employ a temperature sensor user module (FlashTemp) or other temperature sensor, and feed the result to the temperature argument before writing. Refer to the Flash APIs Application Note [AN2015](#) for more information.

NOTES:

- NOTES:
1. 10 SPROCKET HOLE PITCH CUMULATIVE TOLERANCE ± 0.2
 2. CAMBER IN COMPLIANCE WITH EIA 481
 3. POCKET POSITION RELATIVE TO SPROCKET HOLE MEASURED AS TRUE POSITION OF POCKET, NOT POCKET HOLE



Package	Cover Tape Width (mm)	Hub Size (inches)	Minimum Leading Empty Pockets	Minimum Trailing Empty Pockets	Standard Full Reel Quantity
28-Pin SSOP	13.3	7	42	25	1000
48-Pin SSOP	25.5	4	32	19	1000

Development Tool Selection

This section presents the development tools available for the CY8C29x66 family.

Software

PSoC Designer™

At the core of the PSoC development software suite is PSoC Designer, used to generate PSoC firmware applications. PSoC Designer is available free of charge at <http://www.cypress.com> and includes a free C compiler.

PSoC Programmer

Flexible enough to be used on the bench in development, yet suitable for factory programming, PSoC Programmer works either as a standalone programming application or it can operate directly from PSoC Designer or PSoC Express. PSoC Programmer software is compatible with both PSoC ICE-Cube In-Circuit Emulator and PSoC MiniProg. PSoC programmer is available free of charge at <http://www.cypress.com>.

Development Kits

All development kits can be purchased from the [Cypress Online Store](#). The online store also has the most up to date information on kit contents, descriptions, and availability.

CY3215-DK Basic Development Kit

The **CY3215-DK** is for prototyping and development with PSoC Designer. This kit supports in-circuit emulation and the software interface allows users to run, halt, and single step the processor and view the contents of specific memory locations. Advanced emulation features are also supported through PSoC Designer. The kit includes:

- ICE-Cube unit
- 28-pin PDIP emulation pod for CY8C29466-24PXI
- 28-pin CY8C29466-24PXI PDIP PSoC device samples (two)
- PSoC Designer software CD
- ISSP cable
- MiniEval socket programming and evaluation board
- Backward compatibility cable (for connecting to legacy pods)
- Universal 110/220 power supply (12 V)
- European plug adapter
- USB 2.0 cable
- Getting Started guide
- Development kit registration form

Evaluation Tools

All evaluation tools can be purchased from the [Cypress Online Store](#). The online store also has the most up to date information on kit contents, descriptions, and availability.

CY3210-PSoCEval1

The **CY3210-PSoCEval1** kit features an evaluation board and the MiniProg1 programming unit. The evaluation board includes an LCD module, potentiometer, LEDs, an RS-232 port, and plenty of breadboarding space to meet all of your evaluation needs. The kit includes:

- Evaluation board with LCD module
- MiniProg programming unit
- 28-pin CY8C29466-24PXI PDIP PSoC device sample (2)
- PSoC Designer software CD
- Getting Started guide
- USB 2.0 cable

CY3210-29X66 Evaluation Pod (EvalPod)

PSoC EvalPods are pods that connect to the ICE (CY3215-DK kit) to allow debugging capability. They can also function as a standalone device without debugging capability. The EvalPod has a 28-pin DIP footprint on the bottom for easy connection to development kits or other hardware. The top of the EvalPod has prototyping headers for easy connection to the device's pins. **CY3210-29X66** provides evaluation of the CY8C29x66 PSoC device family.

Ordering Information

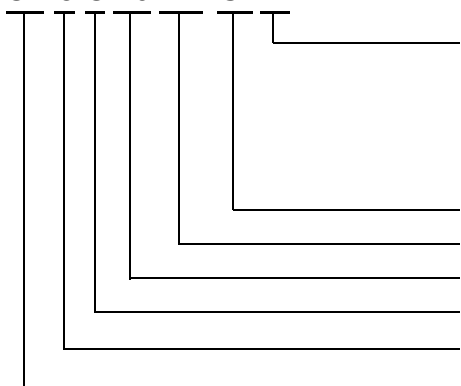
The following table lists the automotive CY8C29x66 PSoC devices' key package features and ordering codes.

Table 38. CY8C29x66 Automotive PSoC Device Key Features and Ordering Information

Package	Ordering Code	Flash (KB)	RAM (KB)	Temperature Range	Digital PSoC Blocks	Analog PSoC Blocks	Digital I/O Pins	Analog Inputs	Analog Outputs	XRES Pin
28-pin (210-Mil) SSOP	CY8C29466-24PVXA	32	2	–40 °C to +85 °C	16	12	24	12 ^[26]	4	Yes
28-pin (210-Mil) SSOP (tape and reel)	CY8C29466-24PVXAT	32	2	–40 °C to +85 °C	16	12	24	12 ^[26]	4	Yes
48-pin (300-Mil) SSOP	CY8C29666-24PVXA	32	2	–40 °C to +85 °C	16	12	44	12 ^[26]	4	Yes
48-pin (300-Mil) SSOP (tape and reel)	CY8C29666-24PVXAT	32	2	–40 °C to +85 °C	16	12	44	12 ^[26]	4	Yes

Ordering Code Definitions

CY 8 C 29 xxx-SPxx



Package type:
 PX = PDIP Pb-free
 SX = SOIC Pb-free
 PVX = SSOP Pb-free
 LFX/LTX = QFN Pb-free
 AX = TQFP Pb-free

CPU speed: 24 MHz

Part number

Family code

Technology code: C = CMOS

Marketing code: 8 = PSoC

Company ID: CY = Cypress

Thermal Rating:
 A = Automotive –40 °C to +85 °C
 C = Commercial
 E = Automotive Extended –40 °C to +125 °C
 I = Industrial

Note

26. There are eight standard analog inputs on the GPIO. The other four analog inputs connect from the GPIO directly to specific switched-capacitor block inputs. See the [PSoC Technical Reference Manual](#) for more details

Reference Information

Acronyms

The following table lists the acronyms that are used in this document.

Table 39. Acronyms Used in this Datasheet

Acronym	Description	Acronym	Description
AC	alternating current	LVD	low-voltage detect
ADC	analog-to-digital converter	MAC	multiply accumulate
AEC	Automotive Electronics Council	MCU	microcontroller unit
API	application programming interface	MIPS	million instructions per second
CMOS	complementary metal oxide semiconductor	PCB	printed circuit board
CPU	central processing unit	PDIP	plastic dual-in-line package
CRC	cyclic redundancy check	PGA	programmable gain amplifier
CT	continuous time	PLL	phase-locked loop
DAC	digital-to-analog converter	POR	power-on reset
DC	direct current	PPOR	precision POR
DTMF	dual-tone multi-frequency	PRS	pseudo-random sequence
ECO	external crystal oscillator	PSoC [®]	Programmable System-on-Chip
EEPROM	electrically erasable programmable read-only memory	PWM	pulse-width modulator
GPIO	general-purpose I/O	RTC	real time clock
I/O	input/output	SAR	successive approximation register
ICE	in-circuit emulator	SC	switched capacitor
IDE	integrated development environment	SLIMO	slow IMO
I ² C	inter-integrated circuit	SPI	serial peripheral interface
ILO	internal low-speed oscillator	SRAM	static random-access memory
IMO	internal main oscillator	SROM	supervisory read-only memory
IP	intellectual property	SSOP	shrink small-outline package
IrDA	infrared data association	UART	universal asynchronous receiver transmitter
ISSP	in-system serial programming	USB	universal serial bus
LCD	liquid crystal display	WDT	watchdog timer
LED	light-emitting diode	XRES	external reset
LPC	low power comparator		

Reference Documents

CY8CPLC20, CY8CLED16P01, CY8C29x66, CY8C27x43, CY8C24x94, CY8C24x23, CY8C24x23A, CY8C22x13, CY8C21x34, CY8C21x23, CY7C64215, CY7C603xx, CY8CNP1xx, and CYWUSB6953 [PSoC[®] Programmable System-on-Chip Technical Reference Manual \(TRM\)](#) (001-14463)

Design Aids – Reading and Writing PSoC[®] Flash – AN2015 (001-40459)

Understanding Data Sheet Jitter Specifications for Cypress Timing Products – AN5054 (001-14503)

Document Conventions

Units of Measure

The following table lists the units of measure that are used in this document.

Table 40. Units of Measure

Symbol	Unit of Measure	Symbol	Unit of Measure
dB	decibel	mVpp	millivolts peak-to-peak
°C	degree Celsius	nA	nanoampere
fF	femto-farad	ns	nanosecond
kHz	kilohertz	nV	nanovolt
kΩ	kilohm	Ω	ohm
MHz	megahertz	ppm	parts per million
μA	microampere	%	percent
μs	microsecond	pF	picofarad
μV	microvolt	ps	picosecond
μW	microwatt	pA	pikoampere
mA	milliampere	rt-Hz	root hertz
mm	millimeter	V	volt
ms	millisecond	W	watt
mV	millivolt		

Numeric Conventions

Hexadecimal numbers are represented with all letters in uppercase with an appended lowercase 'h' (for example, '14h' or '3Ah'). Hexadecimal numbers may also be represented by a '0x' prefix, the C coding convention. Binary numbers have an appended lowercase 'b' (for example, '01010100b' or '01000011b'). Numbers not indicated by an 'h', 'b', or '0x' are in decimal format.

Glossary

active high	1. A logic signal having its asserted state as the logic 1 state. 2. A logic signal having the logic 1 state as the higher voltage of the two states.
analog blocks	The basic programmable opamp circuits. These are SC (switched capacitor) and CT (continuous time) blocks. These blocks can be interconnected to provide ADCs, DACs, multi-pole filters, gain stages, and much more.
analog-to-digital converter (ADC)	A device that changes an analog signal to a digital signal of corresponding magnitude. Typically, an ADC converts a voltage to a digital number. The digital-to-analog converter (DAC) performs the reverse operation.
Application programming interface (API)	A series of software routines that comprise an interface between a computer application and lower level services and functions (for example, user modules and libraries). APIs serve as building blocks for programmers that create software applications.
asynchronous	A signal whose data is acknowledged or acted upon immediately, irrespective of any clock signal.
bandgap reference	A stable voltage reference design that matches the positive temperature coefficient of V_T with the negative temperature coefficient of V_{BE} , to produce a zero temperature coefficient (ideally) reference.
bandwidth	1. The frequency range of a message or information processing system measured in hertz. 2. The width of the spectral region over which an amplifier (or absorber) has substantial gain (or loss); it is sometimes represented more specifically as, for example, full width at half maximum.

Document History Page

Document Title: CY8C29466, CY8C29666 Automotive PSoC® Programmable System-on-Chip™ Document Number: 001-12899				
Revision	ECN	Orig. of Change	Submission Date	Description of Change
**	772096	HMT	See ECN	New silicon, new document (Revision **).
*A	2697720	VIVG/ PYRS	04/24/09	Updated template Content edits
*B	2769233	BTK	09/25/09	Updated Features section. Updated text of PSoC Functional Overview section. Updated Getting Started section. Made corrections and minor text edits to Pinouts section. Changed the name of some sections for added clarity. Improved formatting of the register tables. Added clarifying comments to some electrical specifications. Changed T _{RAMP} specification per MASJ input. Fixed all AC specifications to conform to a ±5% IMO accuracy. Made other miscellaneous minor text edits. Deleted some non-applicable or redundant information. Added a footnote to clarify that 8 of the 12 analog inputs are regular and the other 4 are direct SC block connections. Updated the Development Tool Selection section. Improved the bookmark structure. Edited F _{IMO6} , T _{ERASEB} , T _{WRITE} , T _{RSCLK} , T _{FSCLK} , V _{IHP} , V _{PPORXR} , and 5 V RefLo specifications according to MASJ input. Removed 'TM' from Programmable System-on-Chip in the title.
*C	2822792	BTK/ AESAs	12/07/2009	Added T _{PRGH} , T _{PRGC} , I _{OL} , I _{OH} , F _{32KU} , DC _{ILO} , and T _{POWERUP} electrical specifications. Updated the footnotes for the DC Programming Specifications table. Added maximum values and updated typical values for T _{ERASEB} and T _{WRITE} electrical specifications. Replaced T _{RAMP} electrical specification with SR _{POWERUP} electrical specification. Added "Contents" on page 2.
*D	2888007	NJF	03/30/2010	Updated Cypress website links. Added T _{BAKETEMP} and T _{BAKETIME} parameters in Absolute Maximum Ratings Updated Packaging Information . Updated Ordering Code Definitions . Removed Third Party Tools and Build a PSoC Emulator into your Board. Updated Development Kits and Evaluation Tools . Updated links in Sales, Solutions, and Legal Information .
*E	2987146	BTK	07/19/2010	Updated Pinouts section to add 48-pin package. Updated Packaging Information section to add 48-pin package. Updated Development Tool Selection section to add 48-pin package development tool information. Updated Ordering Information section to add new 48-pin package product. Moved Acronyms section to the end of the document. Added part number CY8C29666 to the title.
*F	3111512	BTK/NJF	07/25/2011	Updated I ² C timing diagram to improve clarity. Updated wording, formatting, and notes of the AC Digital Block Specifications table to improve clarity. Added V _{DDP} , V _{DDL} , and V _{DDHV} electrical specifications to give more information for programming the device. Updated solder reflow temperature specifications to give more clarity. Updated the jitter specifications. Updated PSoC Device Characteristics table. Updated the F _{32KU} electrical specification. Updated note for R _{PD} electrical specification. Updated note for the T _{STG} electrical specification to add more clarity. Added Tape and Reel Information section. Added C _L electrical specification. Updated Analog Reference specifications. Updated V _{OSOA} , TCV _{OSOA} , V _{OSOB} , and TCV _{OSOB} electrical specifications.
*G	3543452	KAUL	03/06/2012	Updated Tape and Reel Information under Packaging Information .